UNITED STATES SECURITIES AND EXCHANGE COMMISSION Washington, D.C. 20549

FORM 8-K

CURRENT REPORT

Pursuant to Section 13 OR 15(d) of The Securities Exchange Act of 1934

Date of Report (Date of earliest event reported) July 29, 2005

Brush Engineered Materials Inc.

(Exact name of registrant as specified in its charter)

	Ohio	001-15885	34-1919973
(St	ate or other jurisdiction of incorporation)	(Commission File Number)	(IRS Employer Identification No.)
	17876 St. Clair Avenue, Cleveland, O	Phio	44110
	(Address of principal executive office	es)	(Zip Code)
Re	gistrant's telephone number, including area code	216-486-4200	
		X . A . B . 11	
		Not Applicable	
	(Former na	ame or former address, if changed since last	report.)
	eck the appropriate box below if the Form 8-K for following provisions (see General Instruction A	-	e filing obligation of the registrant under any of
	Written communications pursuant to Rule 425	under the Securities Act (17 CFR 230.425)	
	Soliciting material pursuant to Rule 14a-12 und	der the Exchange Act (17 CFR 240.14a-12)	
	Pre-commencement communications pursuant	to Rule 14d-2(b) under the Exchange Act (1	7 CFR 240.14d-2(b))
	Pre-commencement communications pursuant	to Rule 13e-4(c) under the Exchange Act (1	7 CFR 240.13e-4(c))
_			

Item 7.01 Regulation FD Disclosure.

On July 29, 2005, Brush Engineered Materials Inc., an Ohio corporation (the "Company"), updated the "Current Investor Update," a slide presentation on its website, a copy of which is attached hereto as Exhibit 99.1. This slide presentation shows the Company's corporate strategy and the financial results through the second quarter of 2005.

Item 9.01 Financial Statements and Exhibits

Exhibits:

Exhibit Number Description of Exhibit

99.1 Current Investor Update

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Brush Engineered Materials Inc.

July 29, 2005 By: /s/ Michael C. Hasychak

Michael C. Hasychak Vice President, Treasurer and Secretary

Brush Engineered Materials Inc. Profile

- Publicly traded since 1956: NYSE-listed since 1972.
- Founded 1931 as Brush Beryllium Company.
 - Building off earlier pioneering technical work at Brush Laboratories
 - Initial scope was development of commercial markets
- With onset of WW II and post war period, significant growth in defense and eventually, aerospace applications
- Mid-70s: major expansion of new commercial markets.
- Today, commercial markets represent 90% + of revenues



Brush Engineered Materials Inc. Profile

- A leading manufacturer of high performance engineered materials
- Operations, service centers and major office locations in North America, Europe and Asia
- Serving long-term growth oriented global markets:
 - Telecommunications and computers
 - Automotive electronics
 - Magnetic and optical data storage
 - Industrial components
 - Aerospace and defense
 - Appliance



Brush Engineered Materials Inc. "Advancing the World's Technologies"

- BEM Materials are found in a wide range of critical and demanding applications requiring:
 - Strength

- Reliability
- Thermal & electrical conductivity
- Miniaturization

- Weight reduction
- Corrosion resistance

- Reflectivity



Brush Engineered Materials Inc. End Uses



Cellular phones and other wireless communications



Notebook and network computers

Electronic components in cars and trucks



Life enhancing devices



Magnetic & Optical Data Storage

Industrial products





Investment Highlights and Strengths

- · Unique Status as Fully Integrated Provider of Beryllium-Containing Products
- · Global Sales and Distribution Network
- · Sales Based on End User Specifications
- · Strong Value Proposition in Served Markets
- · Broad Metallurgical Capabilities in Precious and Non-precious Metals
- Global Leader in High Performance Engineered Materials
- Positive Long-term Market Trends
- · Capacity to Support Profitable Market Growth
- · Strategic Customer Relationships
- · Strong and Improving Sales and Margins
- · Significant Technical Capabilities
- High Barriers to Entry



Brush Engineered Materials Inc. Organized into Two Separate Reportable Segments

Metal Systems

Alloy Products

Beryllium Products

Technical Materials, Inc.

Brush Resources Inc.

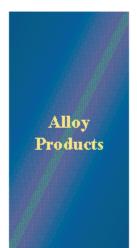
Microelectronics

Electronic Products

Williams Advanced Materials Inc.



Metal Systems Group - 2005 YTD Second Quarter Sales: \$158 million



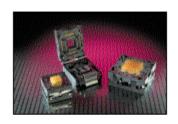
\$103.7 million

- Copper and nickel-based alloy materials, most of which incorporate beryllium
- Strip products are used in electronic connectors including PDA's, wireless communications equipment, notebook and network computers and automotive electronics that require high strength, formability and electrical conductivity
- Bulk products are rod, bar, tube and plate products for industrial and aerospace bushings and bearings, oil & gas components and plastic mold materials where strength, corrosion and wear resistance, thermal conductivity and lubricity are critical performance requirements



\$25.3 million

- Engineered material systems, including clad, plated and electron beam welded metals used in demanding connector applications
- Combines precious and non-precious metals in strip form for use in complex electrical components for telecommunications systems, computers and automotive electronics







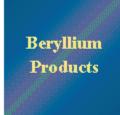






Metal Systems Group - 2005 YTD Second Quarter Sales: \$158 million

Continued



\$25.8 million

 Pure beryllium and aluminum-beryllium composites for high-performance applications, principally for aerospace and defense applications where stiffness, strength, lightweight, dimensional stability and reflectivity are critical



\$3.2 million

 Brush Resources sells beryllium hydroxide produced through its Utah operations to outside customers and to businesses within the Metal Systems Group.





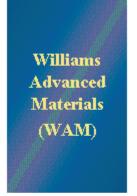








Microelectronics Group - 2005 YTD Second Quarter Sales: \$107 million



\$94.0 million

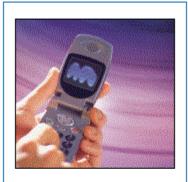
Precious metal and specialty alloys for high reliability applications
Products include precious and non-precious metal vapor deposition targets, frame lid assemblies, clad and precious metal preforms, high-temperature braze materials and ultra fine wire
Industries served include optical media, semi-

Industries served include optical media, semiconductor, data storage, performance film and wireless



\$13.0 million

Products include beryllia ceramic materials, electronic packaging and thick-film circuitry Products designed to meet exacting performance requirements of target customers Industries served include wireless telecommunications, medical laser, aerospace, defense and automotive





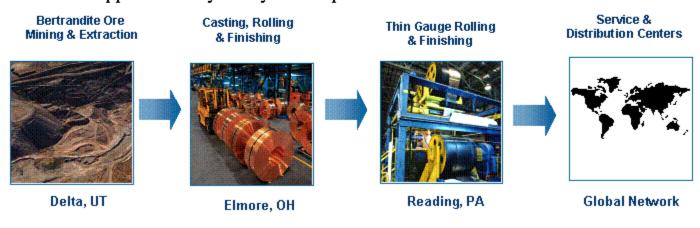






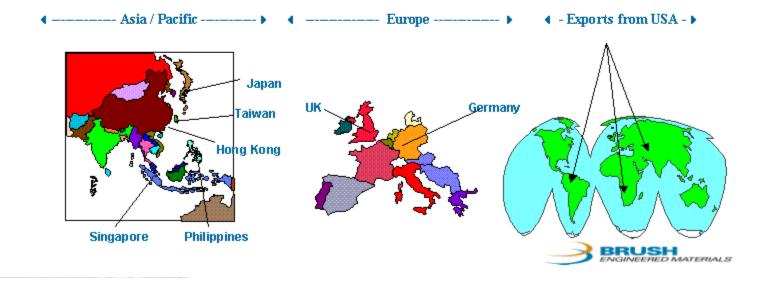
Fully Integrated Beryllium Producer

- Beryllium and beryllium alloys are critical to many high performance applications
 - Strong
 - Lightweight
 - Good formability
- High reliability
- Thermal and electrical conductivity
- Corrosion and wear resistant
- · Operate the only active bertrandite ore mine in the developed world
 - 7,500 acres in Juab County, Utah
 - Approximately 100 years of proven reserves



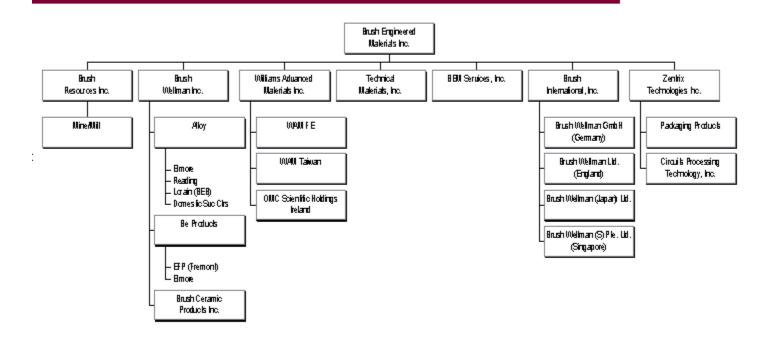
Global Sales and Distribution Network

- Operations in the U.S. and seven foreign countries
- Significant recent expansion to China and Taiwan
- International sales for the first half 2005 were 32%





Corporate Structure

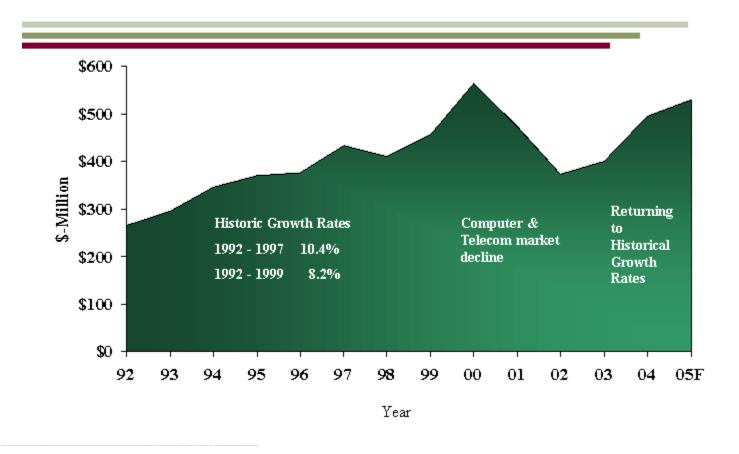


Significant Recent Progress in Key Financial Statistics

\$in millions				YTD
pui illilions	2002	2003	2004	2Q 2005
Sales	\$372.80	\$401.10	\$496.30	\$265.00
EBIT	(22.60)	(8.90)	25.00	13.80
EPS	(2.15)	(.80)	.86	.51
G.P.%	12.9%	18.2%	22.4%	21.89
O.P.%	(6.1%)	(2.2%)	5.0%	5.2%
Depreciation & Amort.	20.60	20.70	22.20	10.70
Capital Spending	5.40	6.30	10.10	4.90
Debt (1)	118.70	99.20	72.50	53.10
Cash	4.40	5.10	49.60	11.20
Debt/Total Cap.	43%	39%	26%	19%

⁽¹⁾ Includes in 2002, synthetic lease

In 2001, the computer and telecom market decline drove sales back to mid-90's levels
In 2003, growth began to return to historical rates
In 2004, growth accelerated



The decline in the telecom/computer market resulted in a 50% drop in the market segment's revenue comparing 2003 to 2000, in 2004, this segment started to grow

\$ in millions				
				Change
	<u>2000</u>	<u>2003</u>	<u>2004</u>	<u>03-04</u>
Telecom/Computer	\$277	\$139	\$206	\$67
Automotive	62	53	59	6
Industrial	62	42	43	1
Magnetic and Optical Data Storage	56	53	52	(1)
Defense/Aerospace	34	37	49	12

All Other _____ \$54 ____ \$50 ____ \$5 ____ \$5 ____ \$564 \$401 \$497 \$96____

19

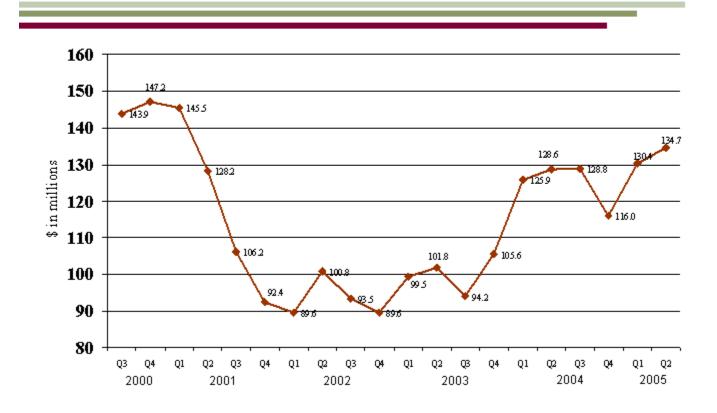
Appliance

27

33

б

Brush experienced a major downturn in Q2 and Q3 2001, with revenue remaining flat through 2002. 2003 was stronger than 2002 and 2004 was stronger than 2003.



Positive Market Trends

- Electronic component manufacturers are being driven by end user demands to produce products that are smaller, lighter and faster
- Increased electronic component performance characteristics require materials that have enhanced mechanical, electrical and thermal properties
- Growing opportunity for thin film physical vapor deposition (PVD) products in the LCD, data storage and semiconductor markets
- Spending and conditions in the telecommunications and computer market have improved
- Conditions are improving in the oil and gas, undersea, aerospace and heavy equipment markets.

Brush has generated year-over-year sales growth in ten consecutive quarters

Capacity to Support Profitable Market Growth

Well-positioned to support rapid sales growth without significant incremental cash investment

- \$140 million invested between 1996 and 2000
- Operating with significant available excess capacity
- · Significant productivity gains in recent years
- Capital spending in 2002, 2003 and 2004 averaged \$7 million per year and the first half of 2005 was \$4.9 million

Financial and Operational Initiatives

Our on-going performance improvement initiatives are focused on five key areas

- Expanding and diversifying the revenue base
 - New products

- New markets

- New applications

- New geographies
- Improving margins through increased operating efficiency
 - Six Sigma and Lean Manufacturing
- · Reducing overhead costs
- · Reducing debt
- · Positioning for global market growth and economic recovery
 - Improve quality, cost, speed and service

Expand and Diversify Revenue Base

Since 2000, BEM has aggressively worked to broaden its base with initiatives targeted at new products, new end use markets and new high-growth regions

New Products

- Alloy 390 Telecom & Auto
- PM Plated Strip Telecom & Auto
- Toughmet Bushings & Bearings
- MoldMax XL Plastic Molds
- Welded Tube Oil & Gas
- Silver DVD Alloy (Silx) -DVD
- Visi-Lid Telecom & Military

New End Use Markets

- Alloy
 - Heavy Equipment
 - Oil & Gas
 Components
 - Plastic Tooling
- WAM
 - Semiconductors
 - Data Storage
 - Magnetic Media
 - Thin Film
 Transistor/Liquid
 Crystal Display

New High-Growth Regions

- Singapore
- Taiwan
- Hong Kong
- Korea
- China

Improving Margins Through Increased Operating Efficiency

Lean Manufacturing and Six Sigma initiatives enabled Brush's Alloy Products business to improve operational efficiency and reduce costs in 2004

- Improved distribution inventory turns 29%
- Improved manufacturing inventory turns 16%
- · Raised yields 7%
- Shipped 13% more pounds per manufacturing employee
- Reduce mill distribution operating cost by 3%
- Reduce strip rework by 28%
- Reduced unplanned equipment downtime 45%
- Improved safety performance by 40%

Reduce Debt

$A\ significant\ reduction\ in\ debt\ has\ occurred$

(\$ in millions)

			Q2
	2000	_2004_	<u>2005</u>
Balance Sheet Debt & AEP Lease	\$128.4	\$ 72.5	\$53.1
Off-balance Sheet Leases	<u>17.9</u>	<u>13.1</u>	<u>12.4</u>
Total	\$146.3	\$85.6	\$65.5
Debt to Debt Plus Equity	36%	26%	19%

Improving Margins Our efforts to improve margins have succeeded, despite the fall in revenue

<u>Year</u>	Gross Margin %	Sales (\$M)
2000	21.0%	\$564
2001	14.4%	473
2002	12.9%	373
2003	18.2%	401
2004	22.4%	496
YTD Q2 2005	21.8%	265

Improved Margins

Margins have improved through cost reduction and productivity improvement initiatives



Programs to improve profitability had a significant impact in 2003 and in 2004

\$ Millions					
					YTD
					Q2
	2001	<u>2002</u>	<u>2003</u>	<u>2004</u>	2005
Net Sales	\$472.6	\$372.8	\$401.0	\$496.3	\$265.0

Oper. Profit (8.9)25.0 (14.1)(22.6)13.8 Oper. % 5.2 (3.0)(6.1)(2.2)5.0

2003 includes the impact of the \$6.0 million refinancing charge. Excluding the charge operating profit would have been \$2.9 million.

Segment Sales Review

\$ in millions	<u>20</u>	01 %	20	002	200	<u>%</u>
	<u> </u>	<u>, o</u>				
 Metal Systems 	\$303.0	64%	\$233.6	63%	\$243.7	61%
- Alloy	217.5	46%	151.9	41%	162.3	40%
- TMI	50.5	11%	44.4	12%	41.9	11%
- Beryllium Products	27.7	6%	31.6	8%	35.2	9%
- Brush Resources*	7.2	1%	5.7	2%	4.3	1%
Microelectronics	\$169.6	36%	\$139.2	37%	\$157.3	39%
- WAM	135.3	29%	109.1	29%	127.8	32%
- Electronic Products	34.3	<u> 7%</u>	_30.1	<u>8%</u>	<u>29.5</u>	<u> 7%</u>
• TOTAL	<u>\$472.6</u>	100%	<u>\$372.8</u>	100%	<u>\$401.0</u>	100%

^{*}Effective 1/1/05 Brush Resources Inc. is included in Metal Systems Group. Prior years have been restated to reflect this change.



Segment Sales Review

\$ in millions	2	004	YTD	Q2 2005
_	\$	<u>%</u>	_\$_	_%
Metal Systems	\$300.7	61%	\$158.0	60%
- Alloy	202.9	41%	103.7	39%
– TMI	53.6	11%	25.3	10%
 Beryllium Products 	39.5	8%	25.8	10%
Brush Resources*	4.7	1%	3.2	1%
 Microelectronics 	195.6	39%	107.0	40%
MAW -	165.7	33%	94.0	35%
 Electronic Products 	29.9	<u>6%</u>	13.0	5%
• TOTAL	<u>\$496.3</u>	100%	<u>\$265.0</u>	100%

^{*}Effective 1/1/05 Brush Resources Inc. is included in Metal Systems Group. Prior years have been restated to reflect this change.



2004 new product and market share growth was 36% of 2004 sales growth

\$ in millions		0-1		New Product
	2003_	Sales 2004	Growth	& Market Share Gain
Metal Systems	\$239.4	\$296.0	\$56.6	\$21.2
– Alloy	162.3	202.9	40.6	10.5
 Beryllium Products 	35.2	39.5	4.3	7.7
- TMI	41.9	53.6	11.7	3.0
 Brush Resources 	4.3	4.7	0.4	0.0
Microelectronics	\$157.3	\$195.6	\$38.3	\$13.0
- WAM	127.8	165.7	37.9	12.0
- Electronic Products	<u>29.5</u>	29.9	0.4	_1.0
• TOTAL	<u>\$401.0</u>	<u>\$496.3</u>	<u>\$95.3</u>	<u>\$34.2</u>



Segment Earnings 2001 - 2005

\$ in millions	<u>2001</u>	2002	<u>2003</u>	2004	YTD Q2 <u>2005</u>
Metal Systems	\$(16.9)	\$(34.8)	\$(16.0)	\$4.2	\$6.1
Microelectronics	4.6	3.8	12.6	18.5	8.5
Other	(1.8)	<u>8.2</u>	(5.5)	2.3	(0.8)
Total Operating Profit	<u>\$(14.1)</u>	<u>\$(22.8)</u>	<u>\$(8.9)</u>	\$25.0	\$13.8

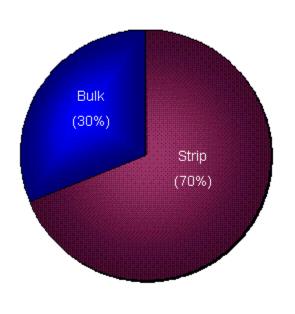


Brush Wellman Alloy Vision

Brush Wellman is the leading supplier of High Performance Copper Alloys worldwide, providing manufacturing excellence in the form of high reliability products and services to satisfy our customers' most demanding applications. We provide these services in a culture of local support and global teamwork.



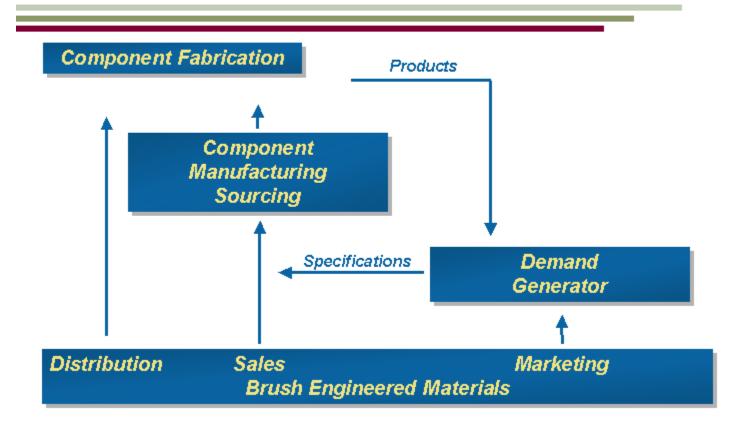
Alloy Products Markets



- > Strip Markets (coils)
 - Telecommunications
 - Computers
 - Automotive Electronics
 - Appliance
- > Bulk Markets (rod, bar, tube, plate)
 - Plastic injection & blow molds
 - Undersea/marine housings for telecom & instrumentation
 - Aircraft bushings & bearings
 - Oilfield well drilling, completion and production equipment
 - Heavy Equipment –Bearing and wear applications
 - Power Generation—Emerging
 - Welding Electrodes and Dies



Sales Based on End User Specifications



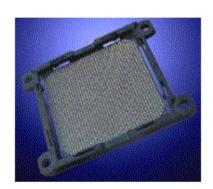
Strip Alloy Applications

(strength, conductivity, spring characteristics)

- Current Carrying Springs and Relays
- Integrated Circuitry Sockets
- Electrical and Electronic Connectors
- Air Bag Sensors
- Pressure Responsive Devices
- Fire Extinguisher Sprinkler Heads









BRUSHWELLMAN

Alloy Products Strip Products - Strategy

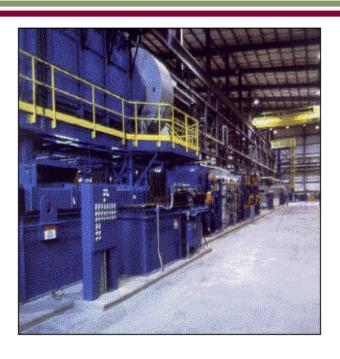
- Maintain focus on 4 major end-use markets
 - Computer Telecommunications (mobile & Infrastructure) Automotive Appliance
- · Defend leadership in traditional alloy strip, rod & wire
 - Reduce total cost of manufacture to allow penetration of mid-range alloy applications
 - Enhance product properties to provide additional value to customers
- Introduce new alloys to meet needs of targeted market opportunities
 - Brush 60®, ToughMet® Strip, Alloy 390™, BrushForm™ 47, BrushForm™ 65
- · Geographic Growth
 - Expand commercial operations in Asia Pacific



New Strip Products - 2005

- Launched Q1 2005
 - BrushFormTM 47 and BrushFormTM 65 Electronics...
 numerous personal portable devices (i.e. cell phones), burnin-test sockets, servers (further expanding property set, i.e.
 formability, conductivity and strength)
- Developed/Targeted for Q3/Q4 2005 Launch
 - Alloy 395 strip Electronics... numerous personal portable devices (i.e. cell phones), burn-in-test sockets, servers (further expanding property set, i.e. higher conductivity)

Strip Capacity Expansion Elmore and Reading Facilities



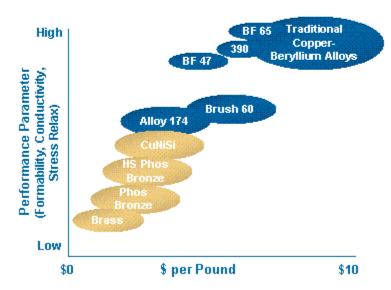
- \$140 Million (1996 1998)
- Added casting, hot rolling, annealing and cold rolling capacity at Elmore
- Added light gauge strip and mill hardening capacity at Reading
- 50% to 100% capacity increase depending upon product



Strong Value Proposition in Served Markets

Copper-beryllium alloys, while premium priced, provide best-in-class performance

Competitive Alloy Comparison



Brush Value Proposition

- Unique, high-performance materials
- · Technical design capabilities
- · Outstanding service
- Global marketing, sales and distribution

Note: Blue denotes Brush Engineered Materials' alloys; beige represents competitive materials.



Automotive Electronics

Definition: power and signal distribution in passenger cars and light trucks - connectors, switches and relays.



Automotive Applications

Potential New Applications:

- Infotronics/telematics in car multimedia systems and mobile communication systems, navigational, global positioning, internet based services
- Powertrain electronics in vehicle networks, drive-by-wire systems, continuously variable transmission, intelligent braking
- Safety systems intelligent air bag systems, driver alertness monitoring, adaptive cruise control, frontal collision warning, intelligent highway vehicle systems, automatic emergency notification



Computer

Definition: Brush Wellman's high performance alloys are sold to the computer industry in strip and wire forms for connectors, contacts, and shielding. End use applications include servers, workstations, notebook and desktop computers, personal digital assistants (PDAs), data storage devices, and semiconductor testing.



Computer Applications

Examples of specific end-use product applications

- Fingerstock shielding used in servers and data storage
- Power connectors used in server power supplies manufactured by Sun, HP, Compaq, and Intel
- Microprocessor socket connectors
- PDA ID connector and battery contacts
- · High speed backplane connector system for data storage and server systems

Examples of future target product applications

- Microprocessor Burn-in and Test Sockets (BiTS)
- Power connectors for multi-chip module interfaces as well as backpanel power applications in high end servers
- High pin count and high density flex circuit interface connectors for high resolution flat panel displays

 BRUSHWELLMAN

Telecommunications

Definition: Brush Wellman's high performance alloys are sold to the telecommunications industry in strip and wire forms for connectors, contacts, shielding, switches and relays. End use applications include wireless base stations, cell phones, pagers, telecom switching equipment, transmission equipment, communication networks, and personal communication devices.



Telecommunication Applications

Examples of specific end-use product applications

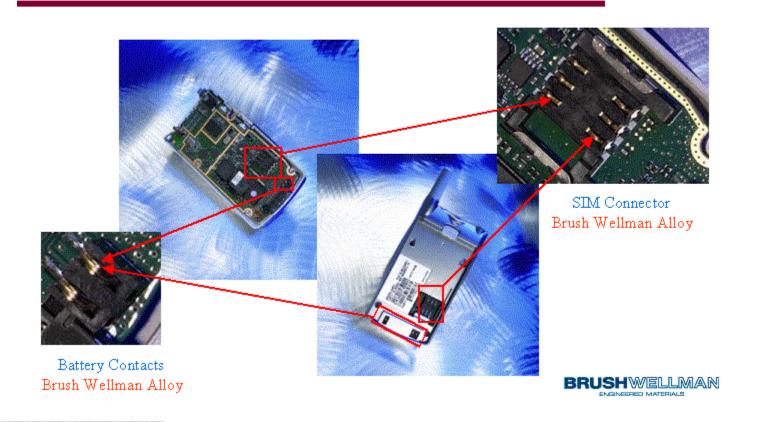
- Handheld and portable device battery contacts, antenna clips, I.O. connectors, board to board connectors, SIM card connectors & display connectors
- · Category 6 modular jacks for connecting data networks
- Shielding gaskets and clips for EMI protection
- · Coaxial connectors for base stations and other telecommunications infrastructure applications
- VHDM connector system used in backpanel connector systems for Gigabit Ethernet switches and routers
- · Circular connectors for military, industrial, and commercial applications

Examples of future target product applications

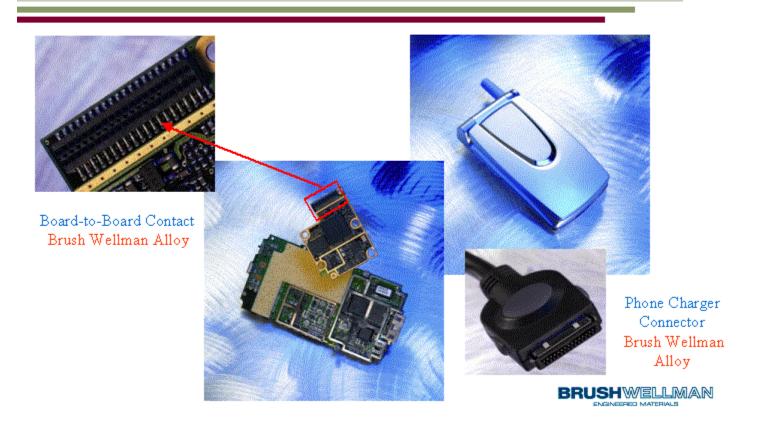
- · Category 7 modular jacks for data networks
- Low profile board to board connectors for wireless handsets and high speed mezzanine connectors for network switches and routers



Cell Phone Connector Applications Rear of Circuit Board

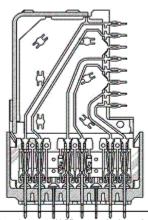


Cell Phone Connector Applications Front of Circuit Board



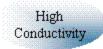
Level 3 (PCB to PCB) Enabling Technologies





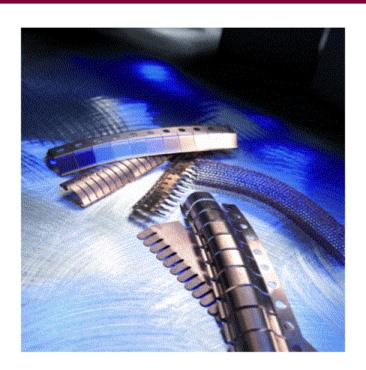
- + Move from single to differential pairs
- + Increased signal speeds
- + High pin count
- + Ground strips can be added between rows
- Weight
- Trace layout problems due to high density



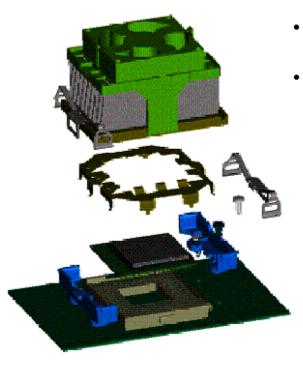




EMI Shielding



EMI Shielding

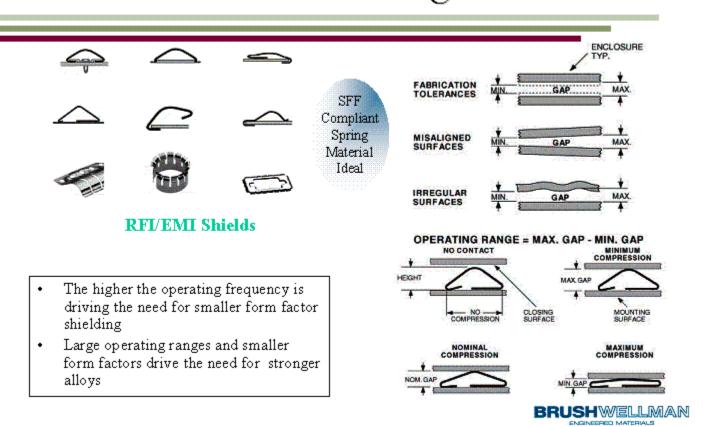


- P4 processor uses an EMI shield for hi-end applications
- Shield is located between the processor and the heat sink exposing it to elevated temperatures

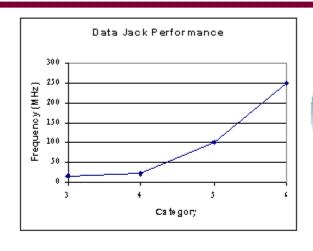
Hi Temperature Exposure



EMI Shielding



Modular Jacks Level 6 (system to System) Enabling Technologies



Hi Reliability Jacks Use HPAs



Cat 6 data jacks

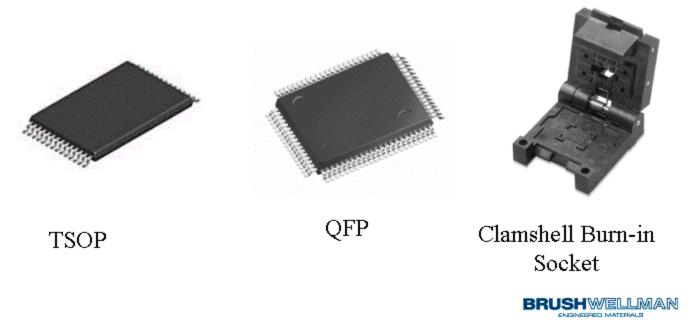
- Normal force
- Impedance
- IDC height
- Return loss
- Cross talk
- Round vs. rectangular
- Attenuation
- Reliability



96 Port Cat 5 patch panel (SRP \$396)



Clamshell Sockets - typically used for TSOP (thin small outline package) and QFP (quad flat package).



LIF Sockets - typically used for DIP (dual in-line package) and SOJ (small outline J-Lead).



DIP



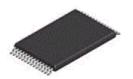
SOJ



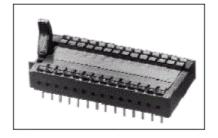
SOJ Burn-in Socket



Clamshell Sockets - typically used for TSOP (thin small outline package) and QFP (quad flat package).



TSOP



ZIF Burn-in Socket



Contact Design Types:

Pogo Pin

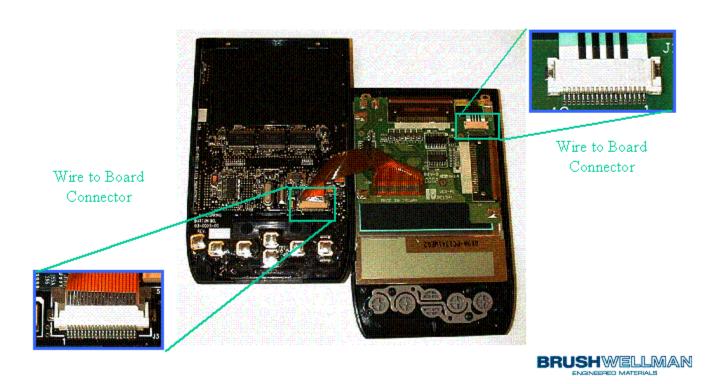
 Made using high performance alloys materials for the spring and contact body

Cantilever Beams

 Made using high performance alloys where careful attention is given to stamping to get good edge quality



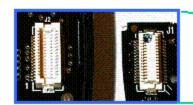
Connectors in PDAs

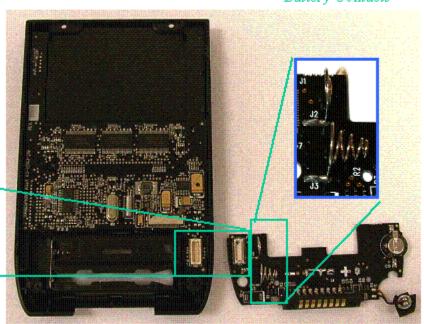


Main PCB from Back

Battery Contacts



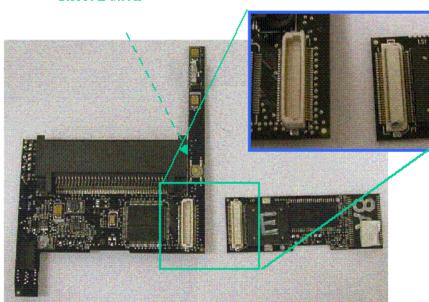






Main PCB from Front

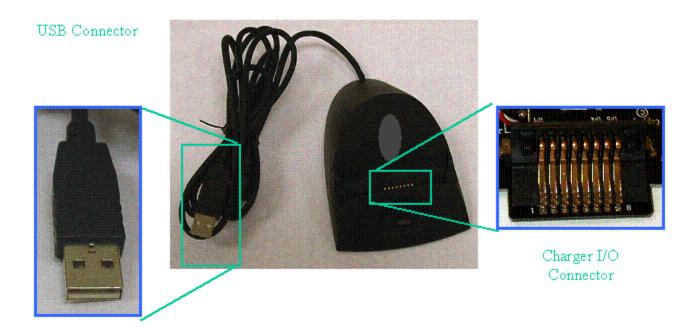
Reset Button



Board to Board Connector



Desktop Charger





Bulk Alloy Applications

(strength, corrosion resistance, non-galling, conductivity)

- Aircraft Bushings
- Oilfield well drilling, completion and production equipment Heavy Equipment Bearing and Wear Applications
- Plastic Injection & Blow Molds
- Power Generation
- Undersea/Marine Housings for Telecom & Instrumentation
- Welding Electrodes & Dies











Alloy Products Bulk Products - Strategy

Maintain focus on traditional end-use markets

- Aerospace Heavy Equipment/Off-Highway Oil & Gas Plastics
 Power Generation Resistance Welding Undersea
- Introduce new alloys or product forms to meet needs of targeted market opportunities.
 - MoldMAX® XL
 - ToughMet[®] and improved ToughMet[®] products (CF ToughMet[®])
 - Alloy 310 RWMA class 3
- Focus on new non-traditional growth markets
 - Bearings, Condensers, Heat Exchangers, Heavy Equipment & Mining, Marine,
 Offshore & Downhole power cables, Oil & Gas well completions, and Pumps
- Geographic Growth
 - Expand commercial operations in Asia Pacific, improve customer awareness and distribution

BRUSHWELLMAN

New Bulk Products - 2005

Developed in 2004 Launched Q1 2005

 ToughMet® AT110 Ring Rolled Forging - Heavy Equipment Applications...larger bushing applications in heavy mining equipment & well-head control equipment

Developed and Launched Q1 2005

 Alloy 25 CuBe rod, tube and forged rings with improved properties for subsea oil & gas well-head equipment

Developed and Launched Q2 2005

 ToughMet 3 TS 160U Rod for bearings and bushings on modern jet aircraft and for oil & gas subsea drilling, completion and production equipment

Developed & Targeted for Q4 2005 Launch

ToughMet®3 TS 110 Rod with high toughness for high pressure oil & gas well drilling, completion and production equipment

TS 160U Tube for modern aircraft bushings and bearings

Q-Max® Welded Tube for process heat exchangers and power plant condensers

MoldMAX® Alloys for the Plastics Industry



Brush Wellman engineers use infrared imaging at the customers facility to pinpoint where MoldMAX® will provide the maximum benefit.

Value Proposition

- Provides molders with 20-40% increase in productivity
- Capital avoidance due to increased productivity
- Enables improved quality of molded parts
- ROI < 3 months

Technical advantages

- Hardness of steel with the thermal conductivity of copper
- · Fast machining rates
- High polishability

Lorain Casting Facility Spinodal and EquacastTM Technology-Winning!

High performance copper based engineered materials:

- · Strength and hardness found in CuBe products
- Thermal conductivity

The value proposition differentiates:

- No EH&S issues
- Corrosion resistance
- Superb tribological properties (low friction coefficient, excellent wear resistance) adding value in reliability, uptime, and maintenance savings
- Machinability and design simplicity adding cost benefits to offset increased material costs
- Casting capability including size, shapes, tubes and quality

Developing applications in markets where we are strong:

Mold Tooling, Aircraft Parts, Drilling Equipment

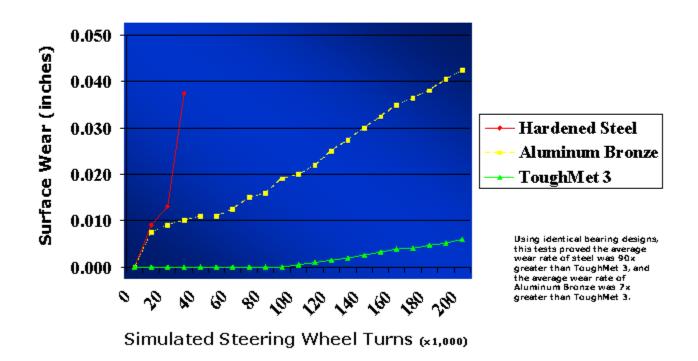
Developing markets/applications where technology is strong:

Oil Well Completion Equipment, Mining, Heavy Equipment, Hydraulic Systems, Marine Hardware, Engine Bearings.

> Lorain Technology: Expanding Brush Wellman's market and application reach



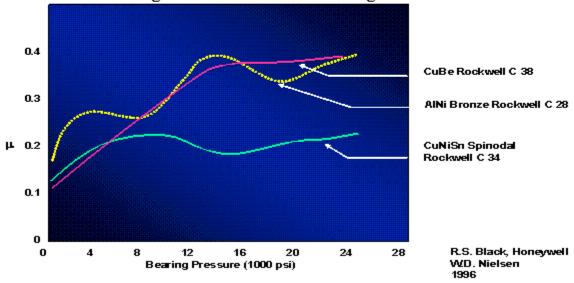
ToughMet® Outlasts Conventional Bearing Materials in 300-ton Mining Truck Steering Test



ToughMet® Industrial Components Results:

ToughMet® Alloy Bushings Provide Superior PowerEfficiency Performance

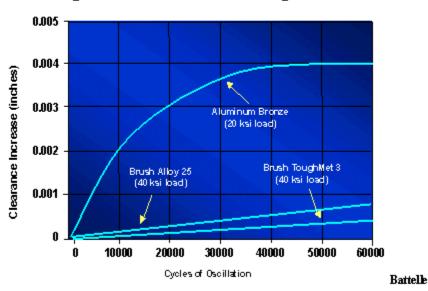
in a Comparison of Dynamic Coefficient of Friction μ vs Bearing Pressure for Three Bearing Materials





Significantly Higher Durability has been Confirmed for ToughMet®

Comparative Sleeve Bearing Wear Tests.





Brush International Inc. Global Sales, Marketing, Distribution & Tech Service

Brush International Inc. S. Freeman - Europe -◆ - Emerging Markets - ▶ Asia / Pacific ----BWS BWT BWC BWJ BWK BWLBWG EXPORTS FROM USA BWG BWG Singapore Taiwan China Japan Korea U.K. Italy Germany Spain Reading Stuttgart Коге Fokyo / Fukaya Shanghai long Kong

Brush International Service Centers

Singapore

Brush Wellman Beryllium Products

Products

Beryllium Metal - One of the lightest metals known

 Family of vacuum hot and hot/cold isostatically pressed powder-derived metals

AlBeMet™

- Family of lightweight alloy composites

 Extruded, rolled sheet and hot isostatically pressed powder-derived metals



Brush Wellman Beryllium Products

Products - Cont.

E-Materials

- Family of low expansion, lightweight electronic packaging materials
- Composites of beryllium metal and beryllium oxide

Beryllium Oxide/

Chemicals

- Ceramic-grade beryllium oxide powder
- Specialty beryllium-containing chemicals

Brush Wellman Beryllium Products

Facilities

Elmore, Ohio Fremont, California



Key Product Attributes

- ➤ Be/AlBeMetTM
 - –Light Weight (Density)
 - -High Stiffness (Elastic Modulus)
 - -High Thermal Conductance/Capacity
 - -Low Thermal Expansion
- ≽ Be
 - Transparent to X-Rays
 - -Neutron Reflector

BRUSHWELLMAN

Brush Wellman Beryllium Products

Primary Competition... Alternative Materials

Organic Composites (e.g. Carbon epoxy)

Silicon carbide

Metal Matrix Composites (e.g. Al - silicon carbide)

Pyrolytic graphite

Aluminum (high strength grades)



Major Defense/Aerospace Applications for Brush Wellman Beryllium Products

Optics

Optical substrate and support structure for visual and infrared target acquisition systems (fighter aircraft, helicopters, unmanned aerial vehicles, tanks), surveillance systems and astronomical telescopes.

Satellites

Structures and sensors for defense and commercial telecommunications satellites.

Electronics

Electronic packaging for defense avionics, radar and electronic countermeasures systems for helicopters and fighter aircraft. Applications include circuit boards, covers and packages.

BRUSHWELLMAN

Major Commercial Applications for Brush Wellman Beryllium Products

X-ray Windows

Radiographic tube components for ★ medical diagnostic (x-ray, mammography, CAT-scan), ★ industrial and (3) scientific equipment.

Optical Scanners

Mirrors for laser scanners used in reprographic and other highperformance laser applications.

Motion control

Structural components for high-precision semiconductor processing and industrial robotic equipment



TMI - From a Customer Perspective

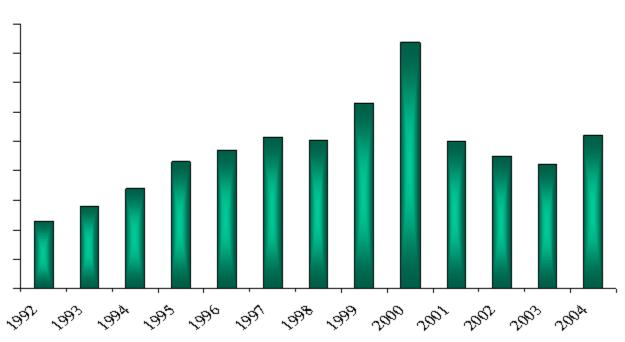


- WHAT TMI provides our customers the ability to demand varied performance (electrical, thermal, or mechanical) from a metal surface area or section.
- WHO We provide this "service" to the telecommunication, automotive, computer, semiconductor and other industries.
- HOW By offering various forms of strip metal products: clad metals, plated metals, electron beam welded, solder plated, reflowed or printed-on, milled and/or skived metal strip or various combinations of the above.

Sales Growth



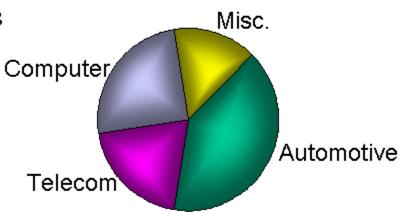




Our Major Markets



- > Automotive
- > Telecommunications
- > Computer
- > Jewelry
- > Semiconductor
- > Appliances
- Medical
- > Aircraft



Our Major Applications



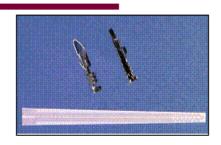


Leadframe



Air Bag Sensor

- Capacitors
- > Coins and Tokens
- Connectors
- Contact Probes
- Fuses
- » Leadframes
- Micro Motor
- Microwave
- Potentiometers
- Relays
- Sensors
- Solder Clips
- » Switches



Connectors



Electroplating



- > Precious and non-precious metals
- > Overall and selective stripe capabilities
- > Combination with current TMI technologies

Stripe Plating Application



Cellular Phone Battery Contact



- Base Material: BeCu
- Overall Ni plating
- Selective Au (one side)
- Selective SnPb (both sides)

Competitive Advantage



- > Quality
 - QS 9000 / ISO 9002 / ISO 14001
 - State-of-the-art equipment
 - Vision Systems / PLC Systems for consistent quality
- Design Support
 - Technical knowledge
 - Engineering expertise
- Overall Capabilities
 - Slitting and leveling
 - Inlay / Electron-Beam Welding / Solder / Milling / Skiving / Plating
 - Any combination of the above processes
 - Large coil handling capability

Strategic Concept



- > Total capability under one roof
- Make it easy for our customers to get what they need to satisfy their customers' requirements
- Make our customers competitive with reliable products
- Solve problems for our customers with engineered strip metal solutions
- Explore and develop new markets and geographic regions for manufacturing (China).

Growth in Electroplating



- > Precious and non-precious metals
- Overall and selective stripe plating capabilities
- Combination with other TMI technologies
- Proprietary closed contact plating technology
- > Building additional lines to further increase capacity

Summary



- > From 1992-2000 TMI sales more than quadrupled.
- 2001 and 2003 proved to be extremely difficult years due to major served markets being severely depressed; however, TMI remained profitable all three years. 2004 has seen a marked increase in sales, but product mix has impacted overall profitability.
- ➤ We have added major new technical capabilities using state-of-the-art equipment in precious metal electroplating to better serve worldwide customer demand (both technical & capacity).
- > We are ISO and QS registered.
- We will add additional Plating technology and capacity to service market demand as required.
- ➤ We are making further inroads into new markets (energy) and other markets (consumer, medical, appliance, construction) in order to broaden our served market base and will have a much different served market profile by 2005/2006.

Our focus is on materials, circuitry, subassemblies and packaging for the wireless and fiber-optic telecom market, military, medical and automotive applications

- Signal amplifiers transmit signals through air (wireless) or optical fiber media by boosting signal strength while maintaining integrity. Thermal management and reliability properties are of paramount importance.
- Signal amplifiers are critical active components located in base stations for wireless (cellular) and in regenerator stations along fiber-optic (Internet) links.

Our Overall Strategy

- Vertically integrate materials to subsystem assembly, providing customized solutions
- > Meet the Customer's needs
 - Materials or subassemblies
- Fast Flexible Manufacturing Systems
 - Responsive to market needs

Business Groups

- > Packaging
 - Electronic Packaging Products
- > Circuitry
 - Circuits Processing Technology
- > Materials
 - Brush Ceramic Products

Electronic Packaging Products

- Located in Newburyport, Massachusetts
- > Products
 - RF Power Packages for base stations in cellular phone
 & wireless data networks, for cellular handsets, for
 military radar applications and for digital TV
 - Automotive Components for ignition systems in cars and trucks
 - Power Circuit Assemblies for DC motor controls

Circuits Processing Technology (CPT)

- Located in Oceanside, California
- > Products
 - High Frequency Military and Aerospace Circuitry used in military radar and missile guidance
 - High Frequency Wireless circuitry for satellite communications, flight hardware and other telecom applications
 - Fiber Optic Package components for amplifiers in fiber optic networks
 - Medical equipment and implant circuitry

Brush Ceramic Products

- Located in Tucson, Arizona
- > Products
 - Ceramic substrates used in commercial and military packaging applications
 - Ceramic laser bores for gas lasers used in medical and industrial applications
 - Machined ceramic components used in military, oil and gas, semiconductor and microwave applications

Williams Advanced Materials Overview

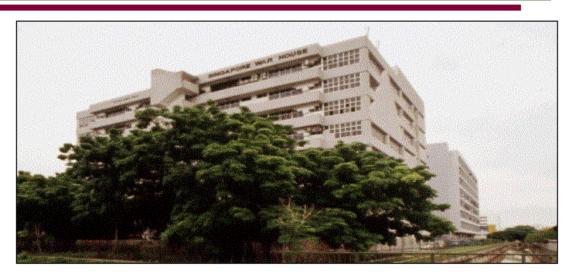
- Williams is a supplier of high-purity, specialty metals serving the wireless, photonics, data storage, high temperature joining, traditional microelectronics and performance film markets.
- Established 1918. Subsidiary of Brush Engineered Materials
- > Business Groups
 - Packaging Material Products Solder preforms, bonding wire, FLA's, clad material and refining. These materials are used in photonic, wireless, traditional semiconductor and hybrid microelectronic packaging applications.
 - Specialty Alloy Products Braze materials and structural alloys. These materials are used in electron tube, photonic and aerospace applications.
 - PVD (Physical Vapor Deposition) products Precious metal and non-precious metal sputtering and evaporation materials, refining and related services. These materials are used in RF devices, LEDs, laser diodes, hard disk drives, digital video discs, hybrid thin film microelectronic devices and performance film applications for medical products.

WAM Headquarters



- > Buffalo, NY USA Manufacturing Facility
 - 100,000 sq. ft. overall, 6,500 sq. ft. of cleanroom, state-of-the-art machining/milling/rolling/stamping/ cladding centers, hydrostatic wire extrusion, high purity refining/recycling, metals casting, automated plating, full analytical capabilities, product Research & Development

Far East Operations



- > Singapore WAM Far East Pte. Ltd.
 - 5,000 sq. ft., 2,500 sq. ft. of cleanroom, automated assembly operations, hydrostatic wire process, product development. PVD bonding operation.

Far East Operations



- > Subic Bay, Philippines
 - Combo-Lid®, low-cost lids and preform assembly, inspection and packaging



Far East Operations



> Taiwan

- Target bonding services.
- Low cost production capabilities.



Specialty Alloys Operations



- > Wheatfield, NY USA- Williams Specialty Alloys
 - 30,000 sq. ft. with volume vacuum casting, rolling, annealing, powder atomizing and machining. 10 acres for expansion



WAM Thin Film Products Operations



- > Brewster, NY USA WAM TFP
 - 35,000 sq. ft. with vacuum melting, hot-pressing, milling, Hot & cold rolling automated machining and target bonding capabilities.
 - Acreage to more than double our facility as needed.

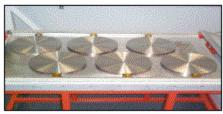


Target Bonding Centers

- ➤ Buffalo, NY
- ➤ Brewster, NY
- ➤ Santa Clara, CA
- > Limerick, Ireland
- > Singapore
- > Taiwan









Williams Advanced Materials Service and Support

> Regional Offices (Sales and Applications Engineering support)

Santa Clara, CA Manila, Philippines

London, England Buffalo, NY

Singapore Tucson, AZ

Taipei, Taiwan Seoul, Korea

Brewster, NY Dallas, TX

> Worldwide Representatives

Florida France Israel

India China Germany

Japan Italy



Williams Advanced Materials Packaging Material Products



Hybrid Microelectronic Device

> Markets

Wireless, Photonics and Hybrid/ Traditional Microelectronic Devices

>Typical End-uses

Cell phones, LEDs, fiber-optic networks, PC's, military electronics, avionics, medical electronics, mobile appliances



Solder preforms and clad materials

>Combo-Lids® - Frame/lid assembly Hermetic sealing

> Clad Materials

Thermal management

> Bonding Wire

Electronic interconnect

> Solder Preforms

Component attachment

» Refining

Scrap recovery



Williams Advanced Materials Specialty Alloy Products



Electron Tube

> Markets

Electron Tube, Photonics, Aerospace, microelectronic packaging

> Typical End-uses

Cellular base stations, lasers, x-ray machines, industrial microwaves



WAMBRAZE_{1M} Materials

> Braze materials

Powder, ribbon and preform

> Structural Alloys

Monel

Cupronickel

Nickel Tunsten



Williams Advanced Materials Physical Vapor Deposition(PVD) Products



Cellular Phone (wireless)



Wireless ICs, semiconductor, optical media, photonics, hard disk drives (disc & thin film heads) and performance films

> Typical End-uses

RF power amplifiers, LEDs, laser diodes, fiber optic components, integrated circuits, DVDs, hard disks, medical devices, MP3 players, mobile electronics



Sputtering Targets

- Precious Metal Sputtering Targets and Evaporation Materials
- > Precious Metal Refining Services
- Non-precious Metal Sputtering Targets and Evaporation Materials



Williams Strategic Leverage

Ensuring Distinctive Abilities Translate to Maximum Returns

- » Over 80 years of metal management and fabrication experience
 - Ability to efficiently manage precious metals critical to customers
- > One-stop Shopping
 - Comprehensive product offering
 - Allows customer to reduce supplier base
- Industry leading lead times
 - Reduces Total Cost to Customer Inventory turns
 - Alleviates long term planning and promotes JIT deliveries
- Fully Integrated Operations
 - In house fabrication, refining and analysis
 - Reduced cycle times and single point of contact for metal needs
- » Service
 - WAM provides a unique, coordinated response to customers
 - We help our customers do their jobs sales, engineering, accounting, etc.
 - We also prepare our customers for the future



Beryllium Health and Safety

Brush has continued to make progress on issues related to beryllium health and safety

- Improved worker protection programs in place
- Rates of sensitization down among new workers
- Strong focus on regulations related to beryllium exposure

Litigation

	Total Cases Pending	Total Plaintiffs (including spouses)
12/31/02	33	70
12/31/03	15	33
12/31/04	12	56
07/01/05	16	61

Litigation

- In Q-2 2005, one additional case was filed, and a second case was voluntarily dismissed by the plaintiff. There was no change in the number of plaintiffs corresponding to these cases in the quarter.
 - Our caseload and number of plaintiffs will vary from quarter to quarter depending on new cases, additional plaintiffs, settlements, dismissals, amendments to complaints, etc.
- The Company believes it has substantial defenses in pending cases